

# Product / Process Change Notification



N° 2019-133-A

Dear Customer,

Please find attached our INFINEON Technologies PCN:

## Change of lead-frame supplier affecting ATSLP packages from Infineon Technologies (Malaysia) Sdn. Bhd.

Important information for your attention:

- Please respond to this PCN by indicating your decision on the approval form, sign it and return to your sales partner before **11<sup>th</sup> November 2019**.
- Infineon aligns with the widely-recognized JEDEC STANDARD "**JESD46**", which stipulates:  
**"Lack of acknowledgement of the PCN within 30 days constitutes acceptance of the change."**

Your prompt reply will help Infineon Technologies to assure a smooth and well executed transition. If Infineon does not hear from your side by the due date, we will assume your full acceptance to this proposed change and its implementation.

Your attention and response to this matter is greatly appreciated.

Infineon Technologies AG  
Postal Address Headquarters: Am Campeon 1-15, D-85579 Neubiberg, Phone +49 (0)89 234-0  
Chairman of the Supervisory Board: Dr. Wolfgang Eder  
Management Board: Dr. Reinhard Ploss (CEO), Dr. Helmut Gassel, Jochen Hanebeck, Dr. Sven Schneider  
Registered Office: Neubiberg  
Commercial Register: München HRB 126492

# Product / Process Change Notification



N° 2019-133-A

## ► Products affected:

Please refer to attached affected product list 1\_cip19133\_a



## ► Detailed Change Information:

**Subject:** Change of lead-frame supplier affecting ATSLP packages from Infineon Technologies (Malaysia) Sdn. Bhd

**Reason:**

- Infineon supplier AAPM has announced discontinuation of its lead-frame business by end of 2019
- Change to Infineon lead-frame supplier QDOS, who is already active for other Infineon components, to assure supply continuity

### Description: Old

### New

#### Leadframe supplier

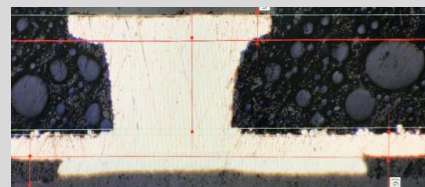
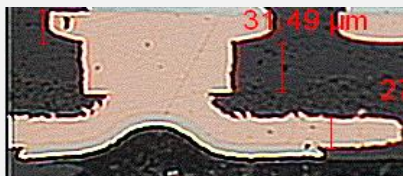
■ AAPM - ASM Advanced Packaging Materials Pte Ltd (Singapore)

■ Qdos Flexcircuits Sdn. Bhd. (Malaysia)

#### Remark: Cross-section comparison

■ AAPM - ASM Advanced Packaging Materials Pte Ltd (Singapore)

■ Qdos Flexcircuits Sdn. Bhd. (Malaysia)



## ► Product Identification:

Internal traceability ensured via baunumber, lot number & date code.  
No change in SP ordering number.

## ► Impact of Change:

Based on the qualification performed, Infineon does not see any negative impact on quality, function and reliability

## ► Attachments:

1\_cip19133\_a: Affected product list

## ► Time Schedule:

- |                               |   |
|-------------------------------|---|
| ■ Final qualification report: | expected 31-October-2019                                |
| ■ First samples available:    | expected 15-October-2019                                |
| ■ Intended start of delivery: | January-2020 or earlier, depending on customer approval |

If you have any questions, please do not hesitate to contact your local Sales office.